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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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Details

Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	EBI/EMI, I ² C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	148
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 21x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-LFQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5630ecdfc-v0

1.4 Pin Functions

Table 1.4 lists the pin functions.

Table 1.4 Pin Functions (1/5)

Classifications	Pin Name	I/O	Description
Power supply	VCC	Input	Power supply pin. Connect it to the system power supply. Connect this pin to VSS via a 0.1-μF capacitor. The capacitor should be placed close to the pin
	VCL	Input	Connect this pin to VSS via a 0.1-μF capacitor. The capacitor should be placed close to the pin
	VSS	Input	Ground pin. Connect it to the system power supply (0 V)
	VBATT	Input	Backup power pin. When the battery backup function is not to be used, connect it to the VCC pin.
Clock	XTAL	Output	Pins for a crystal resonator. An external clock signal can be input through the EXTAL pin
	EXTAL	Input	
	BCLK	Output	Outputs the external bus clock for external devices
	XCOUT	Output	Input/output pins for the sub-clock oscillator circuit. Connect a crystal resonator between XCOUT and XCIN
	XCIN	Input	
Operating mode control	MD	Input	Pin for setting the operating mode. The signal levels on these pins must not be changed during operation
System control	RES#	Input	Reset signal input pin. This LSI enters the reset state when this signal goes low
	EMLE	Input	Input pin for the on-chip emulator enable signal. When the on-chip emulator is used, this pin should be driven high. When not used, it should be driven low
	BSCANP	Input	Boundary scan enable pin. Boundary scan is enabled when this pin goes high. When not used, it should be driven low
On-chip emulator	FINEC	Input	Fine interface clock pin
	FINED	I/O	Fine interface pin
	TRST#	Input	On-chip emulator or boundary scan pins. When the EMLE pin is driven high, these pins are dedicated for the on-chip emulator
	TMS	Input	
	TDI	Input	
	TCK	Input	
	TDO	Output	
	TRCLK	Output	This pin outputs the clock for synchronization with the trace data
	TRSYNC	Output	This pin indicates that output from the TRDATA0 to TRDATA3 pins is valid
	TRDATA0 to TRDATA3	Output	These pins output the trace information
Address bus	A0 to A23	Output	Output pins for the address
Data bus	D0 to D31	I/O	Input and output pins for the bidirectional data bus
Multiplexed bus	A0/D0 to A15/D15	I/O	Address/data multiplexed bus

Table 1.5 List of Pins and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (3/5)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (SCIC, SCID, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD, AD, DA
H1	XTAL	P37					
H2	VSS						
H3	RES#						
H4		P35				NMI	
H12		PA4	A4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0	IRQ5-DS	
H13		PA3	A3	MTIOC0D/MTCLKD/ TIOC0D/TCLKB/PO19	RXD5/SMISO5/SSCL5	IRQ6-DS	
H14		PA2	A2	PO18	RXD5/SMISO5/SSCL5/ SSLA3		
H15	TRDATA3	PG7	D31				
J1	EXTAL	P36					
J2	VCC						
J3		P34		MTIOC0A/TMCI3/PO12/ POE2#	SCK6/SCK0	IRQ4	
J4	TMS	PF3					
J12		PA5	A5	TIOCB1/PO21	RSPCKA		
J13		PK6					
J14		PA7	A7	TIOCB2/PO23	MISOA		
J15		PA6	A6	MTIC5V/MTCLKB/ TIOCA2/TMCI3/PO22/ POE2#	CTS5#/RTS5#/SS5#/ MOSIA		
K1		P33		MTIOC0D/TIOC0D/ TMRI3/PO11/POE3#	RXD6/RXD0/SMISO6/ SMISO0/SSCL6/SSCL0/ CRX0	IRQ3-DS	
K2		P32		MTIOC0C/TIOCC0/ TMO3/PO10/RTCOUT/ RTCIC2	TXD6/TXD0/SMOSI6/ SMOSI0/SSDA6/SSDA0/ CTX0	IRQ2-DS	
K3	TDI	PF2			RXD1/SMISO1/SSCL1		
K4	TCK/FINEC	PF1			SCK1		
K12		PB2	A10	TIOCC3/TCLKC/PO26	CTS4#/RTS4#/CTS6#/ RTS6#/SS4#/SS6#		
K13		P71	CS1#				
K14		PK7					
K15		PB0	A8	MTIC5W/TIOCA3/PO24	RXD4/RXD6/SMISO4/ SMISO6/SSCL4/SSCL6/ RSPCKA	IRQ12	
L1		P31		MTIOC4D/TMCI2/PO9/ RTCIC1	CTS1#/RTS1#/SS1#/ SSLB0	IRQ1-DS	
L2		P30		MTIOC4B/TMRI3/PO8/ RTCIC0/POE8#	RXD1/SMISO1/SSCL1/ MISOB	IRQ0-DS	
L3	TDO	PF0			TXD1/SMOSI1/SSDA1		
L4		P25	CS5#	MTIOC4C/MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/SSCL3		ADTRG0#
L12		PB6	A14	MTIOC3D/TIOCA5/PO30	RXD9/SMISO9/SSCL9		
L13		PB3	A11	MTIOC0A/MTIOC4A/ TIOC0D/TCLKD/TMO0/ PO27/POE3#	SCK4/SCK6		
L14		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD4/TXD6/SMOSI4/ SMOSI6/SSDA4/SSDA6	IRQ4-DS	
L15		P72	CS2#				
M1		P27	CS7#	MTIOC2B/TMCI3/PO7	SCK1/RSPCKB		
M2		P26	CS6#	MTIOC2A/TMO1/PO6	TXD1/CTS3#/RTS3#/ SMOSI1/SS3#/SSDA1/ MOSIB		

Table 1.10 List of Pins and Pin Functions (100-Pin LQFP) (3/3)

Pin Number 100-Pin LQFP	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (SCIC, SCID, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD, AD, DA
67		PA3	A3	MTIOC0D/MTCLKD/ TIOC0D/TCLKB/PO19	RXD5/SMISO5/SSCL5	IRQ6-DS	
68		PA2	A2	PO18	RXD5/SMISO5/SSCL5/ SSLA3		
69		PA1	A1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2	IRQ11	
70		PA0	A0/BC0#	MTIOC4A/TIOCA0/PO16	SSLA1		
71		PE7	D15[A15/D15]		MISOB	IRQ7	AN5
72		PE6	D14[A14/D14]		MOSIB	IRQ6	AN4
73		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B	RSPCKB	IRQ5	AN3
74		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ PO28	SSLB0		AN2
75		PE3	D11[A11/D11]	MTIOC4B/PO26/POE8#	CTS12#/RTS12#/SS12#/ MISOB		AN1
76		PE2	D10[A10/D10]	MTIOC4A/PO23	RXD12/SMISO12/ SSCL12/RXDX12/SSLB3/ MOSIB	IRQ7-DS	AN0
77		PE1	D9[A9/D9]	MTIOC4C/PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12/SSLB2/RSPCKB		ANEX1
78		PE0	D8[A8/D8]		SCK12/SSLB1		ANEX0
79		PD7	D7[A7/D7]	MTIC5U/POE0#		IRQ7	AN7
80		PD6	D6[A6/D6]	MTIC5V/POE1#		IRQ6	AN6
81		PD5	D5[A5/D5]	MTIC5W/POE2#		IRQ5	AN013
82		PD4	D4[A4/D4]	POE3#		IRQ4	AN012
83		PD3	D3[A3/D3]	POE8#		IRQ3	AN011
84		PD2	D2[A2/D2]	MTIOC4D	CRX0*1	IRQ2	AN010
85		PD1	D1[A1/D1]	MTIOC4B	CTX0*1	IRQ1	AN009
86		PD0	D0[A0/D0]			IRQ0	AN008
87		P47				IRQ15-DS	AN007
88		P46				IRQ14-DS	AN006
89		P45				IRQ13-DS	AN005
90		P44				IRQ12-DS	AN004
91		P43				IRQ11-DS	AN003
92		P42				IRQ10-DS	AN002
93		P41				IRQ9-DS	AN001
94	VREFL0						
95		P40				IRQ8-DS	AN000
96	VREFH0						
97	AVCC0						
98		P07				IRQ15	ADTRG0#
99	AVSS0						
100		P05				IRQ13	DA1

Note 1. Enabled only for the ROM capacity of 768 Kbytes or more

Note 2. The BCLK function is multiplexed with the I/O port function for pin P53, so the port function is not available if the external bus is enabled.

Table 1.11 List of Pins and Pin Functions (80-Pin LQFP) (1/3)

Pin Number 100-Pin LQFP	Power Supply Clock System Control	I/O Port	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD, AD, DA
1	VREFH					
2	EMLE					
3	VREFL					
4	VCL					
5	VBATT					
6	MD/FINED					
7	XCIN					
8	XCOUT					
9	RES#					
10	XTAL	P37				
11	VSS					
12	EXTAL	P36				
13	VCC					
14		P35			NMI	
15	TRST#	P34	MTIOC0A/TMC13/PO12/ POE2#	SCK6	IRQ4	
16		P32	MTIOC0C/TIOCC0/TMO3/ PO10/RTCOU/RTIC12	TXD6/SMOSI6/SSDA6	IRQ2-DS	
17	TMS	P31	MTIOC4D/TMC12/PO9/ RTIC1	CTS1#/RTS1#/SS1#/ SSLB0	IRQ1-DS	
18	TDI	P30	MTIOC4B/TMRI3/PO8/ RTIC0/POE8#	RXD1/SMISO1/SSCL1/ MISOB	IRQ0-DS	
19	TCK/FINEC	P27	MTIOC2B/TMC13/PO7	SCK1/RSPCKB		
20	TDO	P26	MTIOC2A/TMO1/PO6	TXD1/SMOSI1/SSDA1/ MOSIB		
21		P21	MTIOC1B/TIOCA3/TMC10/ PO1		IRQ9	
22		P20	MTIOC1A/TIOCB3/TMRI0/ PO0		IRQ8	
23		P17	MTIOC3A/MTIOC3B/ TIOCB0/TCLKD/TMO1/ PO15/POE8#	SCK1/MISOA/SDA2-DS/ IETXD	IRQ7	ADTRG#
24		P16	MTIOC3C/MTIOC3D/ TIOCB1/TCLKC/TMO2/ PO14/RTCOU	TXD1/SMOSI1/SSDA1/ MOSIA/SCL2-DS/IERXD/ USB0_VBUS	IRQ6	ADTRG0#
25		P15	MTIOC0B/MTCLKB/ TIOCB2/TCLKB/TMC12/ PO13	RXD1/SMISO1/SSCL1/ CRX1-DS	IRQ5	
26		P14	MTIOC3A/MTCLKA/ TIOCB5/TCLKA/TMRI2/ PO15	CTS1#/RTS1#/SS1#/ CTX1/USB0_DPUPE	IRQ4	
27		P13	MTIOC0B/TIOCA5/TMO3/ PO13	SDA0[FM+]	IRQ3	ADTRG#
28		P12	TMC1	SCL0[FM+]	IRQ2	
29	VCC_USB					
30				USB0_DM		
31				USB0_DP		
32	VSS_USB					
33		P55	MTIOC4D/TMO3	CRX1	IRQ10	
34		P54	MTIOC4B/TMC1	CTX1		
35		PC7	MTIOC3A/MTCLKB/TMO2/ PO31	TXD8/SMOSI8/SSDA8/ MISOA	IRQ14	
36		PC6	MTIOC3C/MTCLKA/ TMC12/PO30	RXD8/SMISO8/SSCL8/ MOSIA	IRQ13	

Table 1.11 List of Pins and Pin Functions (80-Pin LQFP) (2/3)

Pin Number 100-Pin LQFP	Power Supply Clock System Control	I/O Port	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD, AD, DA
37		PC5	MTIOC3B/MTCLKD/ TMRI2/PO29	SCK8/RSPCKA		
38		PC4	MTIOC3D/MTCLKC/ TMCI1/PO25/POE0#	SCK5/CTS8#/RTS8#/ SS8#/SSLA0		
39		PC3	MTIOC4D/TCLKB/PO24	TXD5/SMOSI5/SSDA5/ IETXD		
40		PC2	MTIOC4B/TCLKA/PO21	RXD5/SMISO5/SSCL5/ SSLA3/IERXD		
41		PB7	MTIOC3B/TIOC5B/PO31	TXD9/SMOSI9/SSDA9		
42		PB6	MTIOC3D/TIOCA5/PO30	RXD9/SMISO9/SSCL9		
43		PB5	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE1#	SCK9		
44		PB4	TIOCA4/PO28	CTS9#/RTS9#/SS9#		
45		PB3	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/TMO0/ PO27/POE3#	SCK6		
46		PB2	TIOCC3/TCLKC/PO26	CTS6#/RTS6#/SS6#		
47		PB1	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD6/SMOSI6/SSDA6	IRQ4-DS	
48	VCC					
49		PB0	MTIC5W/TIOCA3/PO24	RXD6/SMISO6/SSCL6/ RSPCKA	IRQ12	
50	VSS					
51		PA6	MTIC5V/MTCLKB/TIOCA2/ TMCI3/PO22/POE2#	CTS5#/RTS5#/SS5#/ MOSIA		
52		PA5	TIOCB1/PO21	RSPCKA		
53		PA4	MTIC5U/MTCLKA/TIOCA1/ TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0	IRQ5-DS	
54		PA3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/SSCL5	IRQ6-DS	
55		PA2	PO18	RXD5/SMISO5/SSCL5/ SSLA3		
56		PA1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2	IRQ11	
57		PA0	MTIOC4A/TIOCA0/PO16	SSLA1		
58		PE5	MTIOC4C/MTIOC2B	RSPCKB	IRQ5	AN3
59		PE4	MTIOC4D/MTIOC1A/PO28	SSLB0		AN2
60		PE3	MTIOC4B/PO26/POE8#	CTS12#/RTS12#/SS12#/ MISOB		AN1
61		PE2	MTIOC4A/PO23	RXD12/SMISO12/SSCL12/ RXDX12/SSLB3/MOSIB	IRQ7-DS	AN0
62		PE1	MTIOC4C/PO18	TXD12/SMOSI12/SSDA12/ TXDX12/SIOX12/SSLB2/ RSPCKB		ANEX1
63		PE0		SCK12/SSLB1		ANEX0
64		PD2	MTIOC4D		IRQ2	AN010
65		PD1	MTIOC4B		IRQ1	AN009
66		PD0			IRQ0	AN008
67		P47			IRQ15-DS	AN007
68		P46			IRQ14-DS	AN006
69		P45			IRQ13-DS	AN005
70		P44			IRQ12-DS	AN004
71		P43			IRQ11-DS	AN003
72		P42			IRQ10-DS	AN002

3. Address Space

3.1 Address Space

This LSI has a 4-Gbyte address space, consisting of the range of addresses from 0000 0000h to FFFF FFFFh. That is, linear access to an address space of up to 4 Gbytes is possible, and this contains both program and data areas.

Figure 3.1 shows the memory maps in the respective operating modes. Accessible areas will differ according to the operating mode and states of control bits.

Table 4.1 List of I/O Registers (Address Order) (16/42)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 81B4h	TPU9	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 81B5h	TPU9	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 81B6h	TPU9	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 81B8h	TPU9	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 81BAh	TPU9	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 81BCh	TPU9	Timer general register C	TGRC	16	16	2, 3 PCLKB	2 ICLK	
0008 81BEh	TPU9	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK	
0008 81C0h	TPU10	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 81C1h	TPU10	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 81C2h	TPU10	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 81C4h	TPU10	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 81C5h	TPU10	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 81C6h	TPU10	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 81C8h	TPU10	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 81CAh	TPU10	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 81D0h	TPU11	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 81D1h	TPU11	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 81D2h	TPU11	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 81D4h	TPU11	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 81D5h	TPU11	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 81D6h	TPU11	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	PPG
0008 81D8h	TPU11	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 81DAh	TPU11	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 81E6h	PPG0	PPG output control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 81E7h	PPG0	PPG output mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 81E8h	PPG0	Next data enable register H	NDERH	8	8	2, 3 PCLKB	2 ICLK	
0008 81E9h	PPG0	Next data enable register L	NDERL	8	8	2, 3 PCLKB	2 ICLK	
0008 81EAh	PPG0	Output data register H	PODRH	8	8	2, 3 PCLKB	2 ICLK	
0008 81EBh	PPG0	Output data register L	PODRL	8	8	2, 3 PCLKB	2 ICLK	
0008 81ECh*1	PPG0	Next data register H	NDRH	8	8	2, 3 PCLKB	2 ICLK	
0008 81EDh*2	PPG0	Next data register L	NDRL	8	8	2, 3 PCLKB	2 ICLK	
0008 81EEh*1	PPG0	Next data register H	NDRH2	8	8	2, 3 PCLKB	2 ICLK	
0008 81EFh*2	PPG0	Next data register L	NDRL2	8	8	2, 3 PCLKB	2 ICLK	
0008 81F0h	PPG1	PPG trigger select register	PTRSLR	8	8	2, 3 PCLKB	2 ICLK	
0008 81F6h	PPG1	PPG output control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 81F7h	PPG1	PPG output mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 81F8h	PPG1	Next data enable register H	NDERH	8	8	2, 3 PCLKB	2 ICLK	
0008 81F9h	PPG1	Next data enable register L	NDERL	8	8	2, 3 PCLKB	2 ICLK	
0008 81FAh	PPG1	Output data register H	PODRH	8	8	2, 3 PCLKB	2 ICLK	TMR
0008 81FBh	PPG1	Output data register L	PODRL	8	8	2, 3 PCLKB	2 ICLK	
0008 81FCh*3	PPG1	Next data register H	NDRH	8	8	2, 3 PCLKB	2 ICLK	
0008 81FDh*4	PPG1	Next data register L	NDRL	8	8	2, 3 PCLKB	2 ICLK	
0008 81FEh*3	PPG1	Next data register H	NDRH2	8	8	2, 3 PCLKB	2 ICLK	
0008 81FFh*4	PPG1	Next data register L	NDRL2	8	8	2, 3 PCLKB	2 ICLK	
0008 8200h	TMR0	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8201h	TMR1	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8202h	TMR0	Timer control/status register	TCSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8203h	TMR1	Timer control/status register	TCSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8204h	TMR0	Time constant register A	TCORA	8	8	2, 3 PCLKB	2 ICLK	
0008 8205h	TMR1	Time constant register A	TCORA	8	8*5	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (18/42)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 8327h	RIIC1	I ² C bus interrupt enable register	ICIER	8	8	2, 3 PCLKB	2 ICLK	RIIC
0008 8328h	RIIC1	I ² C bus status register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8329h	RIIC1	I ² C bus status register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK	
0008 832Ah	RIIC1	Slave address register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK	
0008 832Ah	RIIC1	Timeout Internal Counter L	TMOCNTL	8	8	2, 3 PCLKB	2 ICLK	
0008 832Bh	RIIC1	Slave address register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK	
0008 832Bh	RIIC1	Timeout Internal Counter U	TMOCNTU	8	8	2, 3 PCLKB	2 ICLK	
0008 832Ch	RIIC1	Slave address register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK	
0008 832Dh	RIIC1	Slave address register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK	
0008 832Eh	RIIC1	Slave address register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK	
0008 832Fh	RIIC1	Slave address register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK	
0008 8330h	RIIC1	I ² C bus bit rate low-level register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	
0008 8331h	RIIC1	I ² C bus bit rate high-level register	ICBRH	8	8	2, 3 PCLKB	2 ICLK	
0008 8332h	RIIC1	I ² C bus transmit data register	ICDRT	8	8	2, 3 PCLKB	2 ICLK	
0008 8333h	RIIC1	I ² C bus receive data register	ICDRR	8	8	2, 3 PCLKB	2 ICLK	
0008 8340h	RIIC2	I ² C bus control register 1	ICCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8341h	RIIC2	I ² C bus control register 2	ICCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8342h	RIIC2	I ² C bus mode register 1	ICMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8343h	RIIC2	I ² C bus mode register 2	ICMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8344h	RIIC2	I ² C bus mode register 3	ICMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 8345h	RIIC2	I ² C bus function enable register	ICFER	8	8	2, 3 PCLKB	2 ICLK	
0008 8346h	RIIC2	I ² C bus status enable register	ICSER	8	8	2, 3 PCLKB	2 ICLK	
0008 8347h	RIIC2	I ² C bus interrupt enable register	ICIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8348h	RIIC2	I ² C bus status register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8349h	RIIC2	I ² C bus status register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK	
0008 834Ah	RIIC2	Slave address register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK	
0008 834Bh	RIIC2	Slave address register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK	
0008 834Ch	RIIC2	Slave address register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK	
0008 834Dh	RIIC2	Slave address register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK	
0008 834Eh	RIIC2	Slave address register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK	
0008 834Fh	RIIC2	Slave address register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK	
0008 8350h	RIIC2	I ² C bus bit rate low-level register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	
0008 8351h	RIIC2	I ² C bus bit rate high-level register	ICBRH	8	8	2, 3 PCLKB	2 ICLK	
0008 8352h	RIIC2	I ² C bus transmit data register	ICDRT	8	8	2, 3 PCLKB	2 ICLK	
0008 8353h	RIIC2	I ² C bus receive data register	ICDRR	8	8	2, 3 PCLKB	2 ICLK	
0008 8360h	RIIC3	I ² C bus control register 1	ICCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8361h	RIIC3	I ² C bus control register 2	ICCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8362h	RIIC3	I ² C bus mode register 1	ICMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8363h	RIIC3	I ² C bus mode register 2	ICMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8364h	RIIC3	I ² C bus mode register 3	ICMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 8365h	RIIC3	I ² C bus function enable register	ICFER	8	8	2, 3 PCLKB	2 ICLK	
0008 8366h	RIIC3	I ² C bus status enable register	ICSER	8	8	2, 3 PCLKB	2 ICLK	
0008 8367h	RIIC3	I ² C bus interrupt enable register	ICIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8368h	RIIC3	I ² C bus status register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8369h	RIIC3	I ² C bus status register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK	
0008 836Ah	RIIC3	Slave address register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK	
0008 836Bh	RIIC3	Slave address register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK	
0008 836Ch	RIIC3	Slave address register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK	
0008 836Dh	RIIC3	Slave address register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK	
0008 836Eh	RIIC3	Slave address register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (19/42)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 836Fh	RIIC3	Slave address register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK	RIIC
0008 8370h	RIIC3	I ² C bus bit rate low-level register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	
0008 8371h	RIIC3	I ² C bus bit rate high-level register	ICBRH	8	8	2, 3 PCLKB	2 ICLK	
0008 8372h	RIIC3	I ² C bus transmit data register	ICDRT	8	8	2, 3 PCLKB	2 ICLK	
0008 8373h	RIIC3	I ² C bus receive data register	ICDRR	8	8	2, 3 PCLKB	2 ICLK	
0008 8380h	RSPI0	RSPI control register	SPCR	8	8	2, 3 PCLKB	2 ICLK	RSPI
0008 8381h	RSPI0	RSPI slave select polarity register	SSLP	8	8	2, 3 PCLKB	2 ICLK	
0008 8382h	RSPI0	RSPI pin control register	SPPCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8383h	RSPI0	RSPI status register	SPSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8384h	RSPI0	RSPI data register	SPDR	32	16, 32	2, 3 PCLKB	2 ICLK	
0008 8388h	RSPI0	RSPI sequence control register	SPSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8389h	RSPI0	RSPI sequence status register	SPSSR	8	8	2, 3 PCLKB	2 ICLK	
0008 838Ah	RSPI0	RSPI bit rate register	SPBR	8	8	2, 3 PCLKB	2 ICLK	
0008 838Bh	RSPI0	RSPI data control register	SPDCR	8	8	2, 3 PCLKB	2 ICLK	
0008 838Ch	RSPI0	RSPI clock delay register	SPCKD	8	8	2, 3 PCLKB	2 ICLK	
0008 838Dh	RSPI0	RSPI slave select negation delay register	SSLND	8	8	2, 3 PCLKB	2 ICLK	
0008 838Eh	RSPI0	RSPI next-access delay register	SPND	8	8	2, 3 PCLKB	2 ICLK	
0008 838Fh	RSPI0	RSPI control register 2	SPCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8390h	RSPI0	RSPI command register 0	SPCMD0	16	16	2, 3 PCLKB	2 ICLK	
0008 8392h	RSPI0	RSPI command register 1	SPCMD1	16	16	2, 3 PCLKB	2 ICLK	
0008 8394h	RSPI0	RSPI command register 2	SPCMD2	16	16	2, 3 PCLKB	2 ICLK	
0008 8396h	RSPI0	RSPI command register 3	SPCMD3	16	16	2, 3 PCLKB	2 ICLK	
0008 8398h	RSPI0	RSPI command register 4	SPCMD4	16	16	2, 3 PCLKB	2 ICLK	
0008 839Ah	RSPI0	RSPI command register 5	SPCMD5	16	16	2, 3 PCLKB	2 ICLK	
0008 839Ch	RSPI0	RSPI command register 6	SPCMD6	16	16	2, 3 PCLKB	2 ICLK	
0008 839Eh	RSPI0	RSPI command register 7	SPCMD7	16	16	2, 3 PCLKB	2 ICLK	
0008 83A0h	RSPI1	RSPI control register	SPCR	8	8	2, 3 PCLKB	2 ICLK	
0008 83A1h	RSPI1	RSPI slave select polarity register	SSLP	8	8	2, 3 PCLKB	2 ICLK	
0008 83A2h	RSPI1	RSPI pin control register	SPPCR	8	8	2, 3 PCLKB	2 ICLK	
0008 83A3h	RSPI1	RSPI status register	SPSR	8	8	2, 3 PCLKB	2 ICLK	
0008 83A4h	RSPI1	RSPI data register	SPDR	32	16, 32	2, 3 PCLKB	2 ICLK	
0008 83A8h	RSPI1	RSPI sequence control register	SPSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 83A9h	RSPI1	RSPI sequence status register	SPSSR	8	8	2, 3 PCLKB	2 ICLK	
0008 83AAh	RSPI1	RSPI bit rate register	SPBR	8	8	2, 3 PCLKB	2 ICLK	
0008 83ABh	RSPI1	RSPI data control register	SPDCR	8	8	2, 3 PCLKB	2 ICLK	
0008 83ACh	RSPI1	RSPI clock delay register	SPCKD	8	8	2, 3 PCLKB	2 ICLK	
0008 83ADh	RSPI1	RSPI slave select negation delay register	SSLND	8	8	2, 3 PCLKB	2 ICLK	
0008 83AEh	RSPI1	RSPI next-access delay register	SPND	8	8	2, 3 PCLKB	2 ICLK	
0008 83AFh	RSPI1	RSPI control register 2	SPCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 83B0h	RSPI1	RSPI command register 0	SPCMD0	16	16	2, 3 PCLKB	2 ICLK	
0008 83B2h	RSPI1	RSPI command register 1	SPCMD1	16	16	2, 3 PCLKB	2 ICLK	
0008 83B4h	RSPI1	RSPI command register 2	SPCMD2	16	16	2, 3 PCLKB	2 ICLK	
0008 83B6h	RSPI1	RSPI command register 3	SPCMD3	16	16	2, 3 PCLKB	2 ICLK	
0008 83B8h	RSPI1	RSPI command register 4	SPCMD4	16	16	2, 3 PCLKB	2 ICLK	
0008 83BAh	RSPI1	RSPI command register 5	SPCMD5	16	16	2, 3 PCLKB	2 ICLK	
0008 83BCh	RSPI1	RSPI command register 6	SPCMD6	16	16	2, 3 PCLKB	2 ICLK	
0008 83BEh	RSPI1	RSPI command register 7	SPCMD7	16	16	2, 3 PCLKB	2 ICLK	
0008 83C0h	RSPI2	RSPI control register	SPCR	8	8	2, 3 PCLKB	2 ICLK	
0008 83C1h	RSPI2	RSPI slave select polarity register	SSLP	8	8	2, 3 PCLKB	2 ICLK	
0008 83C2h	RSPI2	RSPI pin control register	SPPCR	8	8	2, 3 PCLKB	2 ICLK	

Table 5.5 DC Characteristics (4) (for G Version (+85 < Ta ≤ +105°C))

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, T_a = T_{opr}

Item				Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Supply current*1	High-speed operating mode	Max.*2		I _{CC} *3	—	—	115	mA	ICLK = 100 MHz PCLKB = 50 MHz FCLK = 50 MHz BCLK = 50 MHz	
		Normal	Peripheral function: clock signal supplied*4		—	52	—			
			Peripheral function: clock signal stopped*4		—	40	—			
		Sleep mode			—	25	75			
		All-module-clock-stop mode (reference value)			—	20	45			
		Increased by BGO operation*5			—	15	—			
	Low-speed operating mode 1*6				—	4	—			ICLK = 1 MHz ICLK = 32.768 kHz
	Low-speed operating mode 2				—	1	—			
	Software standby mode				—	0.2	6			
	Deep software standby mode	Power supplied to RAM and USB resume detecting unit			—	22	200	μA		
		Power not supplied to RAM and USB resume detecting unit	Power-on reset circuit and low-power function enabled consumption function disabled		—	21	60			
			Power-on reset circuit and low-power function enabled consumption function enabled		—	6.2	28			
		Increased by RTC operation			—	3	—			
		RTC operation when VCC is off			—	1.7	—		V _{BATT} = 2.3 V	
					—	3.3	—	V _{BATT} = 3.3 V		
Analog power supply current*7	During 12-bit A/D conversion (including temperature sensor)			I _{AVCC0}	—	2.3	3.2	mA		
	During 10-bit A/D conversion			I _{VREFH} *7	—	1.0	1.65	mA		
	During D/A conversion (per unit)				—	0.7	1.0	mA		
	Waiting for A/D, D/A conversion (all units)*8			—	—	25	35	μA		
	A/D, D/A converter in standby mode (all units)*8				—	0.1	5	μA		
Reference power supply current	During 12-bit A/D conversion			I _{VREFH0}	—	0.6	0.7	mA		
	Waiting for 12-bit A/D conversion (per unit)				—	0.5	0.6	mA		
	12-bit A/D converter in standby mode (per unit)				—	0.1	2.0	μA		
RAM standby voltage				V _{RAM}	2.7	—	—	V		
VCC rising gradient				SrVCC	8.4	—	20000	μs/V		
VCC falling gradient*8				SfVCC	8.4	—	—	μs/V		

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.

Note 2. Measured with clocks supplied to the peripheral functions. This does not include the BGO operation.

Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK:PCLK:BCLK:BCLK pin = 8:4:4:2)

I_{CC} Max. = 0.87 × f + 13 (max. operation in high-speed operating mode)

I_{CC} Typ. = 0.35 × f + 5 (normal operation in high-speed operating mode)

I_{CC} Typ. = 1.0 × f + 3 (low-speed operating mode 1)

I_{CC} Max. = 0.48 × f + 12 (sleep mode)

Note 4. This does not include the BGO operation.

Note 5. This is the increase for programming or erasure of the ROM or flash memory for data storage during program execution.

Note 6. Supply of the clock signal to peripherals is stopped in this state. This does not include the BGO operation.

Note 7. The current values for 10-bit A/D converter and 10-bit D/A converter are included in the current from the VREFH pin.

Note 8. The values are the sum of I_{AVCC0} and I_{VREFH}.

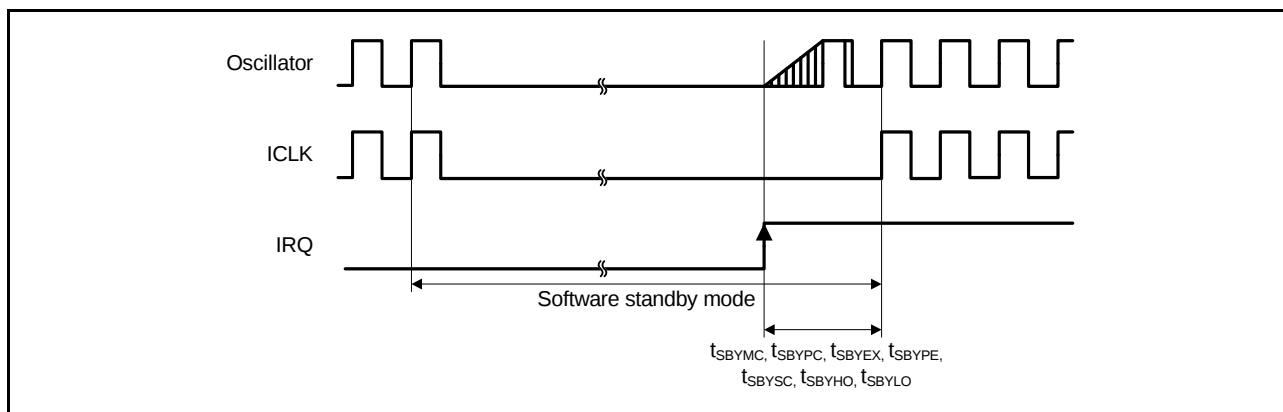


Figure 5.13 Software Standby Mode Cancellation Timing

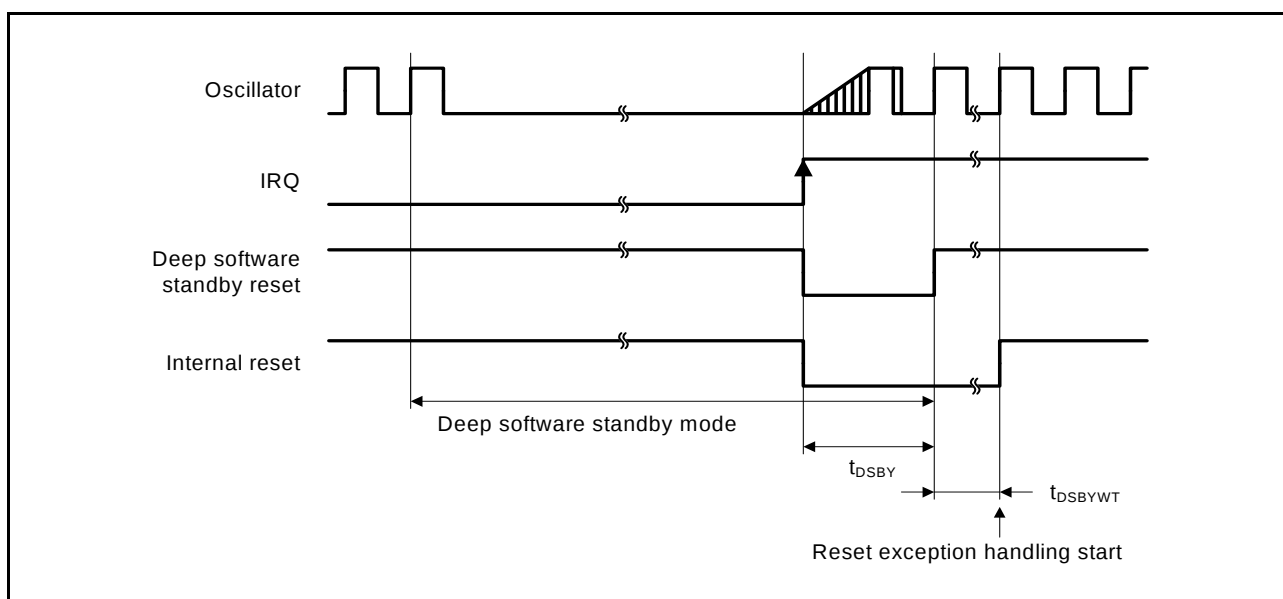


Figure 5.14 Deep Software Standby Mode Cancellation Timing

5.3.4 Control Signal Timing

Table 5.14 Control Signal Timing

Conditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to AV_{CC0} ,
 $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
NMI pulse width	t_{NMIW}	200	—	—	ns	$t_c (PCLK) \times 2 \leq 200$ ns Figure 5.15
		$t_c (PCLK) \times 2$				$t_c (PCLK) \times 2 > 200$ ns Figure 5.15
IRQ pulse width	t_{IRQW}	200	—	—	ns	$t_c (PCLK) \times 2 \leq 200$ ns Figure 5.16
		$t_c (PCLK) \times 2$				$t_c (PCLK) \times 2 > 200$ ns Figure 5.16

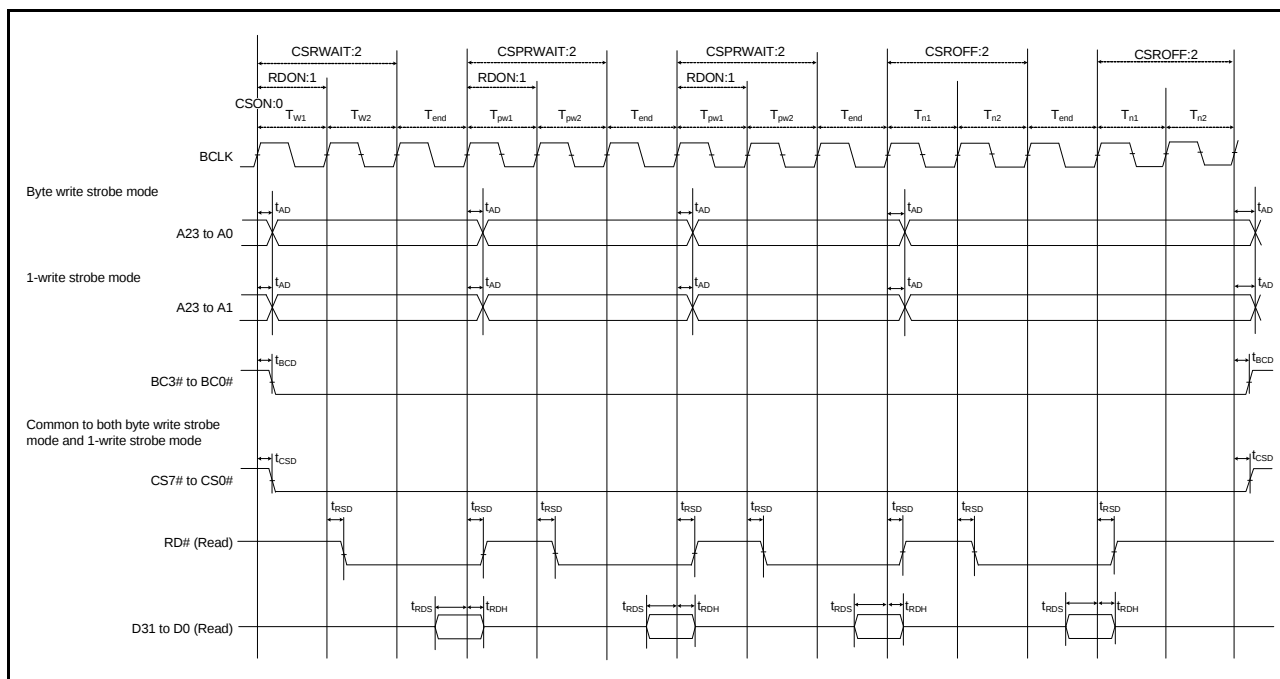


Figure 5.21 External Bus Timing/Page Read Cycle (Bus Clock Synchronized)

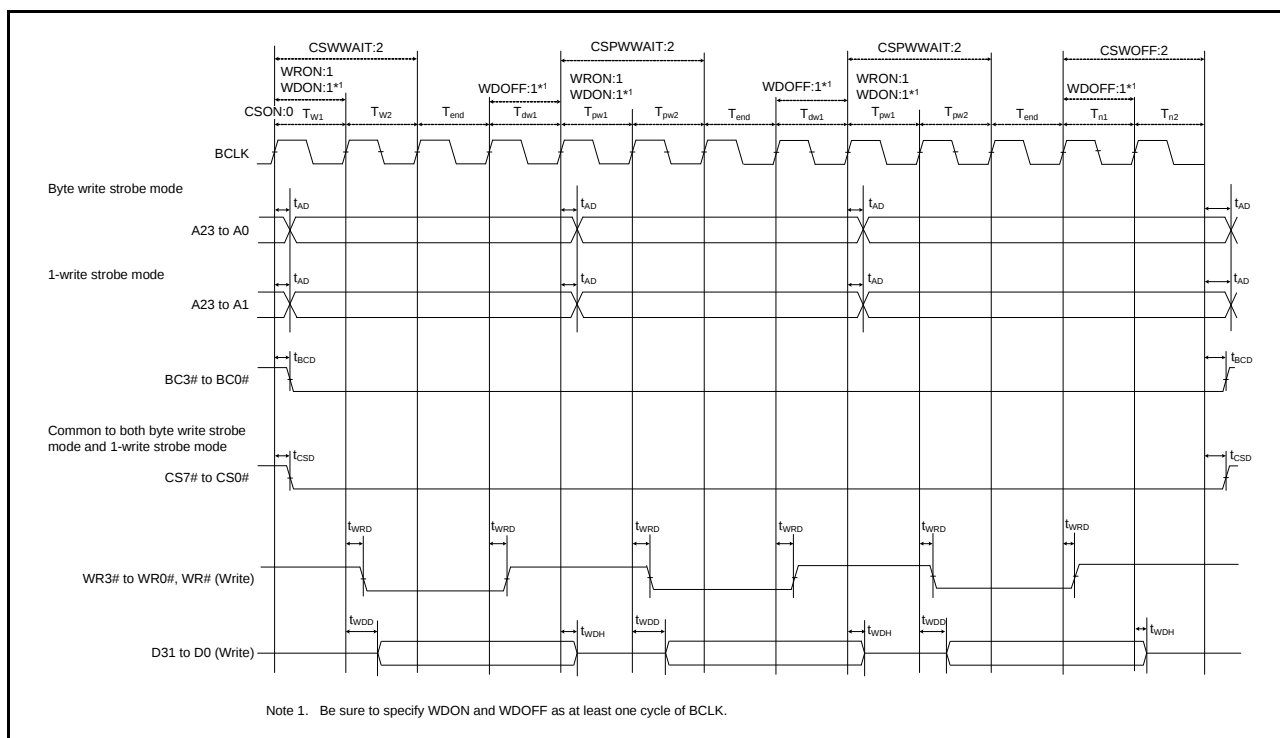


Figure 5.22 External Bus Timing/Page Write Cycle (Bus Clock Synchronized)

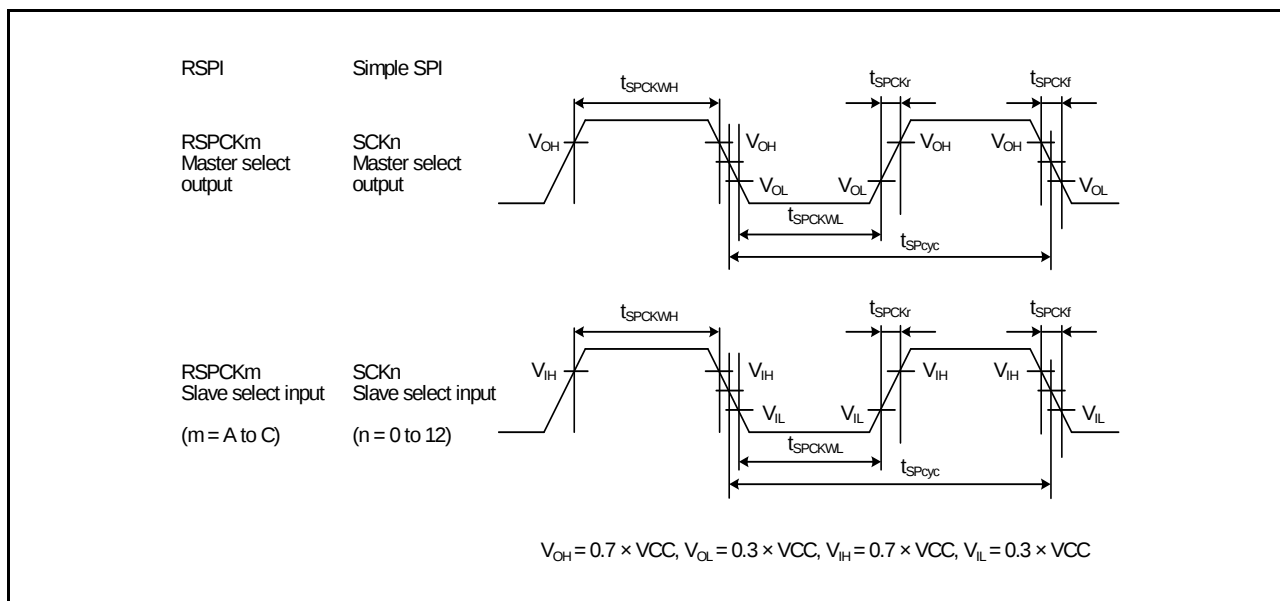


Figure 5.32 RSPI Clock Timing and Simple SPI Clock Timing

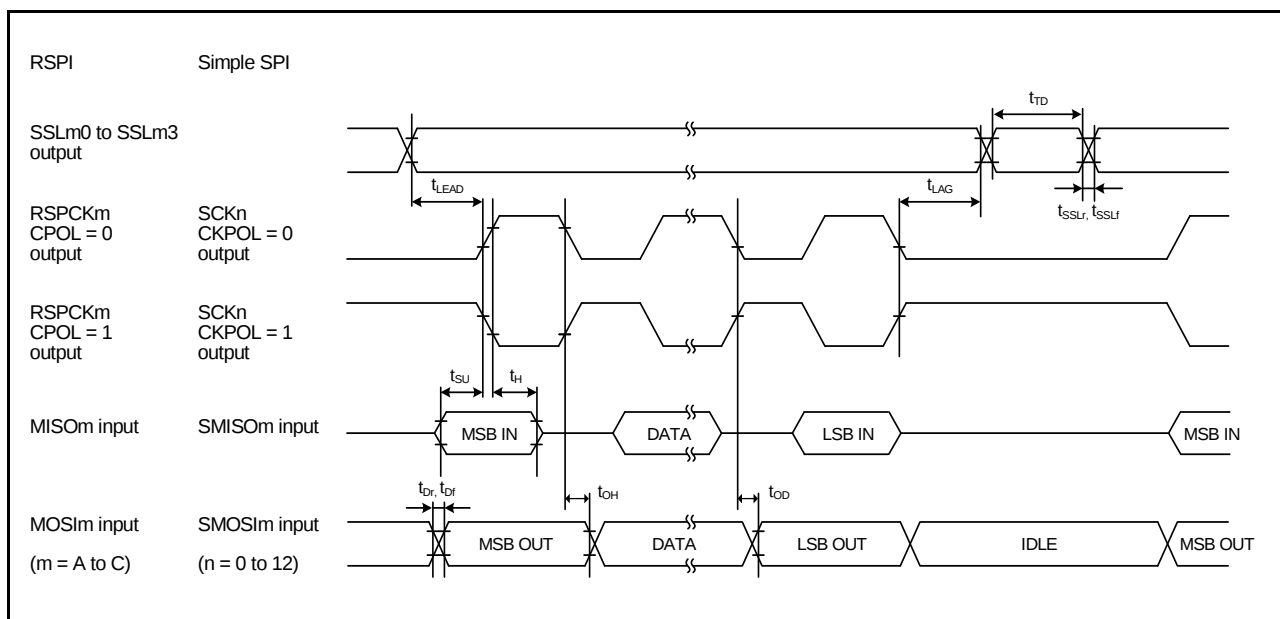


Figure 5.33 RSPI Timing (Master, CPHA = 0) and Simple SPI Timing (Master, CKPH = 1)

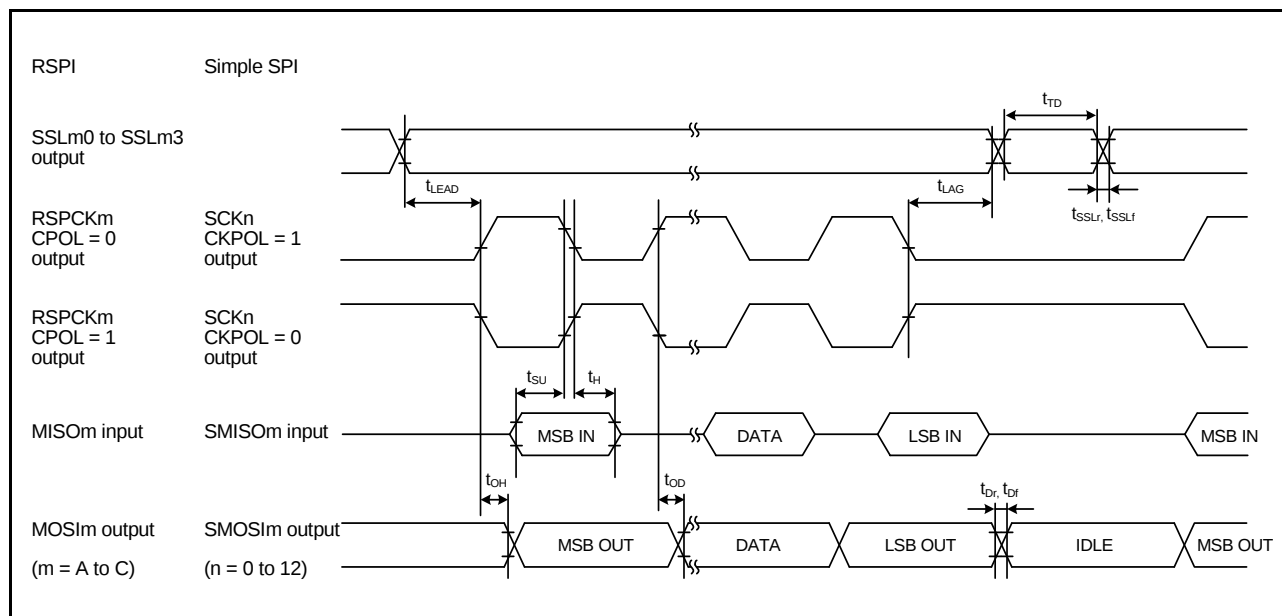


Figure 5.34 RSPI Timing (Master, CPHA = 1) and Simple SPI Timing (Master, CKPH = 0)

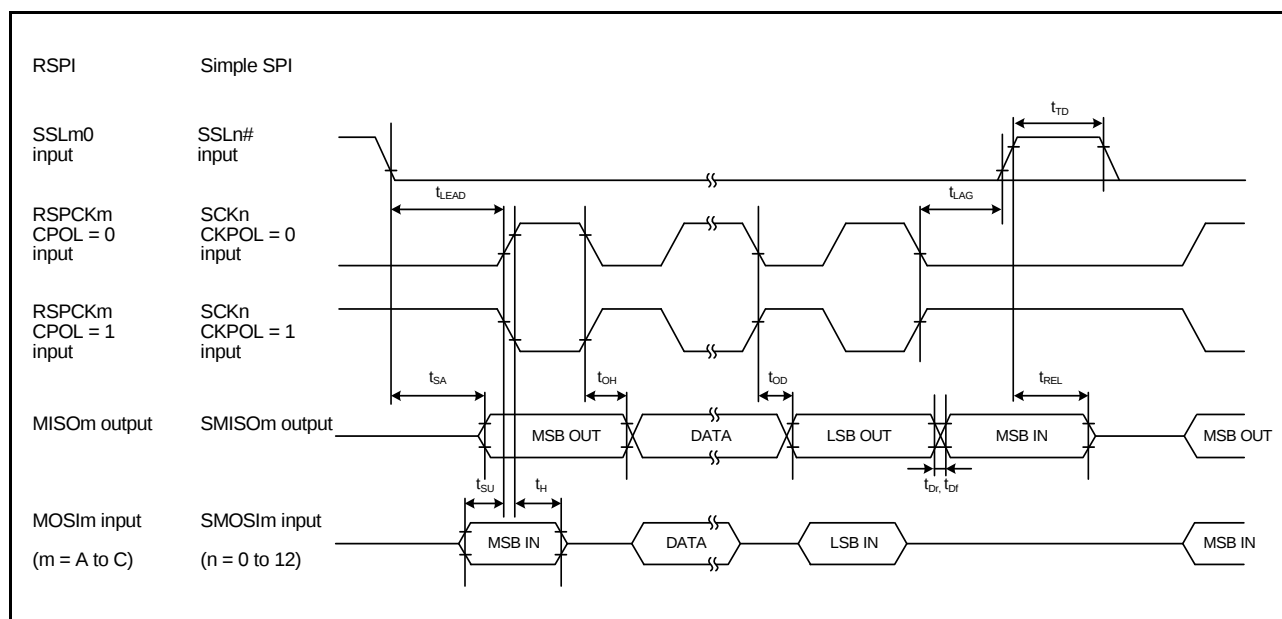


Figure 5.35 RSPI Timing (Slave, CPHA = 0) and Simple SPI Timing (Slave, CKPH = 1)

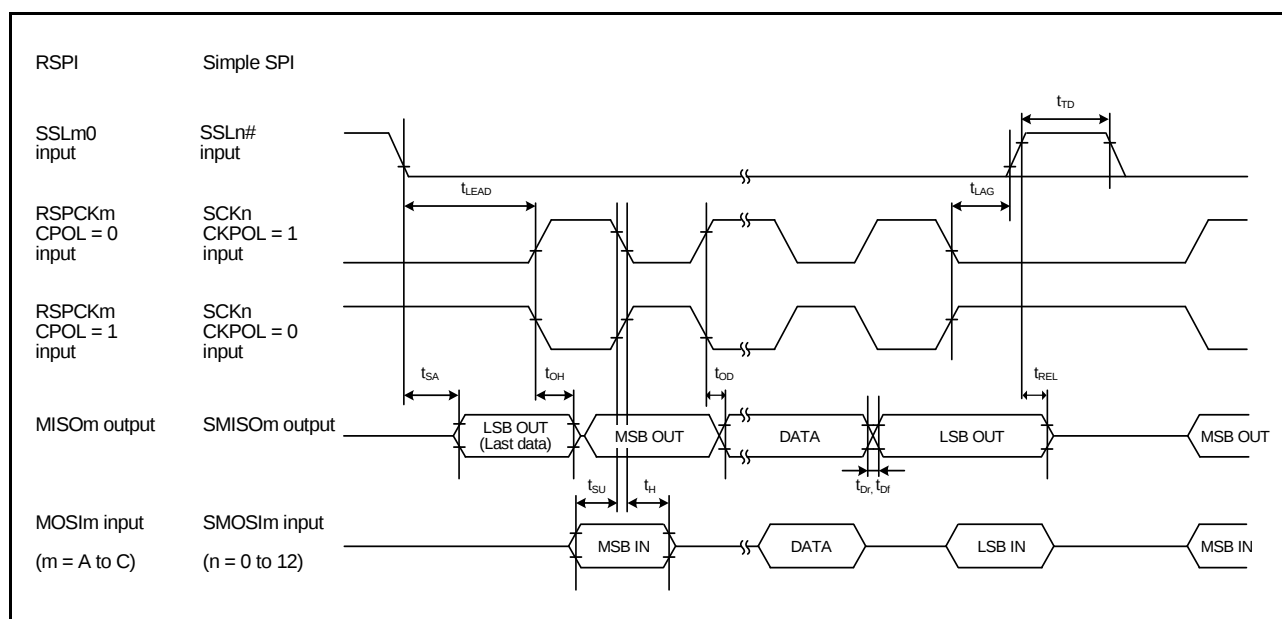


Figure 5.36 RSPI Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 0)

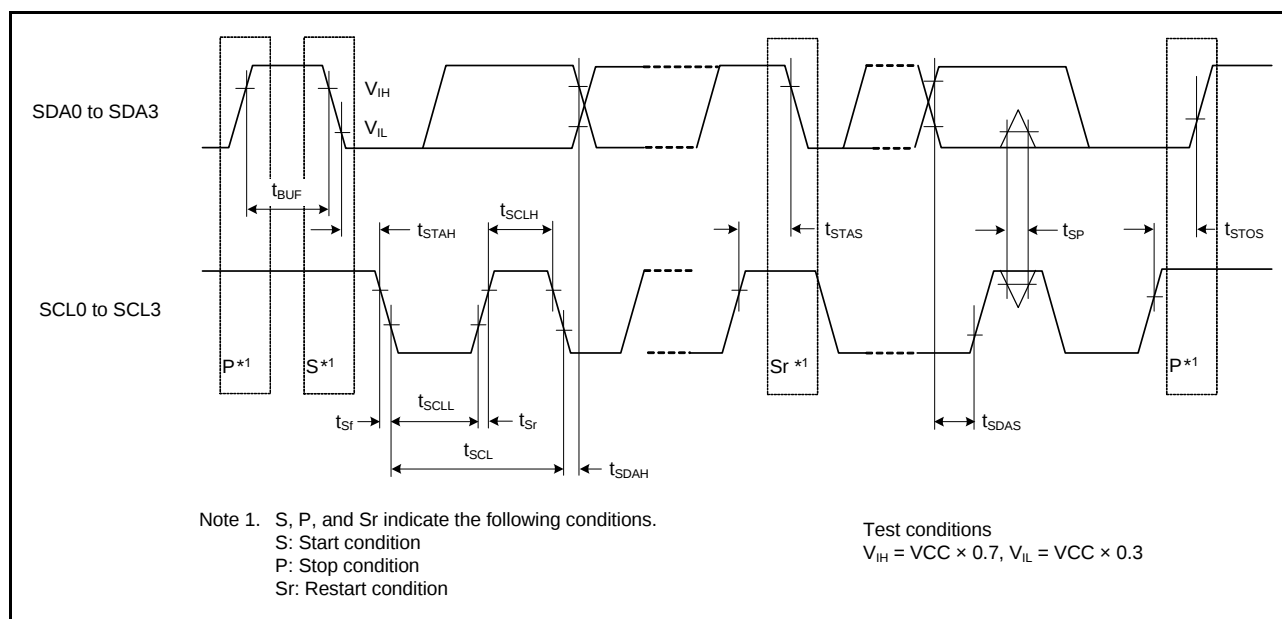


Figure 5.37 RIIC Bus Interface Input/Output Timing and Simple IIC Bus Interface Input/Output Timing

5.5 A/D Conversion Characteristics

Table 5.22 10-Bit A/D Conversion CharacteristicsConditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to AV_{CC0} $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V $PCLK = 8$ to 50 MHz $T_a = T_{opr}$

Item			Min.	Typ.	Max.	Unit	Test Conditions
Resolution			10	10	10	Bit	
Conversion time*1 (Operation at PCLK = 50 MHz)	With 0.1-μF external capacitor	When the capacitor is charged enough*2	3.0 (2.5)*3	—	—	μs	Sampling in 125 states
	Without 0.1-μF external capacitor	Permissible signal source impedance (max.) = 1.0 kΩ, VCC ≥ 3.0 V	1.5 (1.0)*3	—	—		Sampling in 50 states
		Permissible signal source impedance (max.) = 1.0 kΩ, VCC ≥ 2.7 V	3.5 (3.0)*3	—	—		Sampling in 150 states
		Permissible signal source impedance (max.) = 5.0 kΩ, VCC ≥ 3.0 V	2.0 (1.5)*3	—	—		Sampling in 75 states
		Permissible signal source impedance (max.) = 5.0 kΩ, VCC ≥ 2.7 V	4.0 (3.5)*3	—	—		Sampling in 175 states
Analog input capacitance			—	—	6.0	pF	
Offset error			—	±1.5	±3.0	LSB	
Full-scale error			—	±1.5	±3.0	LSB	
Quantization error			—	±0.5	—	LSB	
Absolute accuracy			—	±1.5	±3.0	LSB	
DNL differential nonlinearity error			—	±0.5	±1.0	LSB	
INL integral nonlinearity error			—	±1.5	±3.0	LSB	

Note: The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds during A/D conversion, values may not fall within the above ranges.

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The scanning is not supported.

Note 3. The value in parentheses indicates the sampling time.

5.9 Oscillation Stop Detection Timing

Table 5.28 Oscillation Stop Detection Circuit Characteristics

Conditions: $V_{CC} = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$
 $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V
 $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Detection time	t_{dr}	—	—	1	ms	Figure 5.44

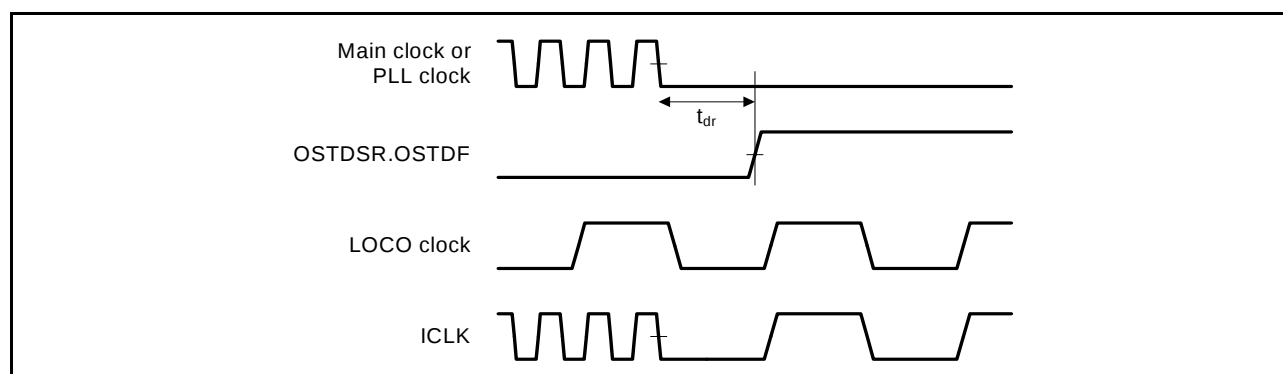


Figure 5.44 Oscillation Stop Detection Timing

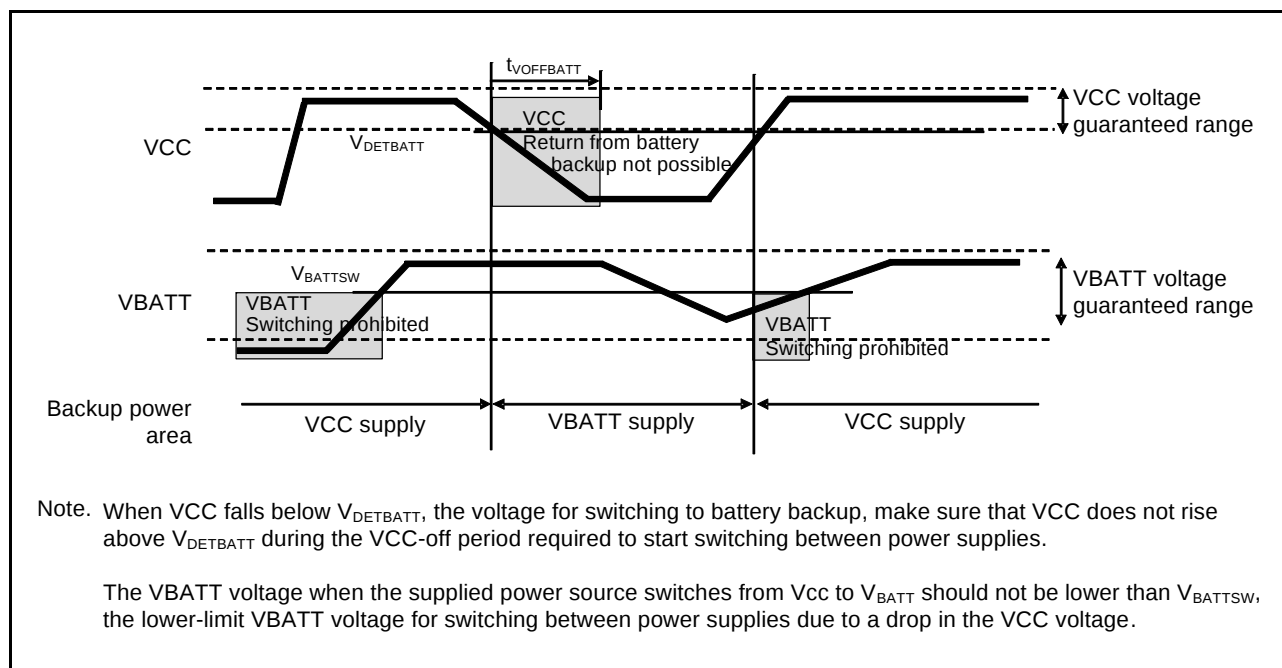
5.10 Battery Backup Function Characteristics

Table 5.29 Battery Backup Function Characteristics

Conditions: $V_{CC} = AVCC0 = V_{REFH} = V_{CC_USB} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to $AVCC0$, $V_{BATT} = 2.3$ to 3.6 V
 $V_{SS} = AVSS0 = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V
 $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage level for switching to battery backup	$V_{DETBATT}$	2.50	2.60	2.70	V	Figure 5.45
Lower-limit VBATT voltage for power supply switching due to VCC voltage drop	V_{BATTSW}	2.70	—	—		
VCC-off period for starting power supply switching	$t_{VOFFBATT}$	200	—	—	μs	

Note: The VCC-off period for starting power supply switching indicates the period in which VCC is below the minimum value of the voltage level for switching to battery backup ($V_{DETBATT}$).

**Figure 5.45 Battery Backup Function Characteristics**

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.